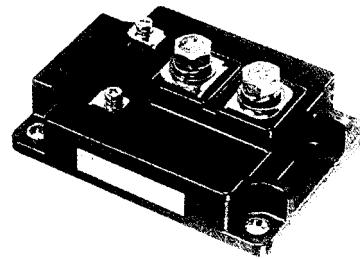


1MBI600PX-140

e-Front runners

IGBT Module P-Series

1400V / 600A 1 in one-package



■ Features

- Small temperature dependence of the turn-off switching loss
- Easy to connect in parallel
- Wide RBSOA (square up to 2 time of rated current) and high short-circuit withstand capability
- Low loss and soft-switching (reduction of EMI noise)

■ Applications

- General purpose inverter
- AC Servo systems (Drive unit)
- UPS (Uninterruptible Power Supply)

■ Maximum ratings and characteristics

● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Conditions	Rating	Unit
Collector-Emitter voltage	V_{CES}		1400	V
Gate-Emitter voltage	V_{GES}		± 20	V
Collector current	I_C	Continuous $T_c=25^\circ\text{C}$	800	A
		$T_c=80^\circ\text{C}$	600	
	I_C pulse	1ms $T_c=25^\circ\text{C}$	1600	
		$T_c=80^\circ\text{C}$	1200	
	$-I_C$	Continuous	600	
	$-I_C$ pulse	1ms	1200	
Collector Power Dissipation	P_C		4100	W
Junction temperature	T_J		$+150$	$^\circ\text{C}$
Storage temperature	T_{STG}		-40 to +125	
Isolation voltage between terminal and copper base *1	V_{ISO}	AC:1min.	2500	VAC
Screw Torque	Mounting *2		4.5	N·m
	Terminals *3		11.0	
	*4		1.7	

*1 : All terminals should be connected together when isolation test will be done.

Recommendable value : *2 4.0±0.5 N·m(M6), *3 10.0±1.0 N·m(M8), *4 1.50±0.2 N·m(M4)

● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

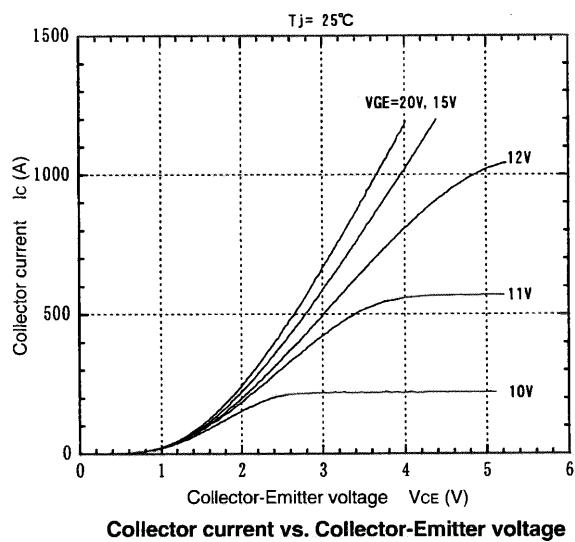
Item	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Zero gate voltage collector current	I_{CES}	$V_{GE}=0\text{V}$, $V_{CE}=1400\text{V}$	—	—	2.0	mA
Gate-Emitter leakage current	I_{GES}	$V_{CE}=0\text{V}$, $V_{GE}=\pm 20\text{V}$	—	—	0.5	μA
Gate-Emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=20\text{V}$, $I_C=600\text{mA}$	6.0	8.0	9.0	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15\text{V}$, $I_C=600\text{A}$, $T_j=25^\circ\text{C}$	—	2.85	3.2	V
Input capacitance	C_{IES}	$V_{CE}=10\text{V}$	—	60	—	nF
Output capacitance	C_{OES}	$V_{GE}=0\text{V}$	—	9	—	
Reverse transfer capacitance	C_{RES}	$f=1\text{MHz}$	—	4	—	
Turn-on time	t_{on}	$V_{CC}=600\text{V}$ $I_C=600\text{A}$	—	0.75	1.20	μs
	t_r		—	0.20	0.60	
Turn-off time	t_{off}	$V_{GE}=\pm 15\text{V}$ $R_G=2.0\ \Omega$	—	0.65	1.00	
	t_f		—	0.10	0.30	
Diode forward on voltage	V_F	$I_F=600\text{A}$, $V_{GE}=0\text{V}$	—	—	3.4	V
Reverse recovery time	t_{rr}	$I_F=600\text{A}$	—	—	0.35	μs

● Thermal resistance characteristics

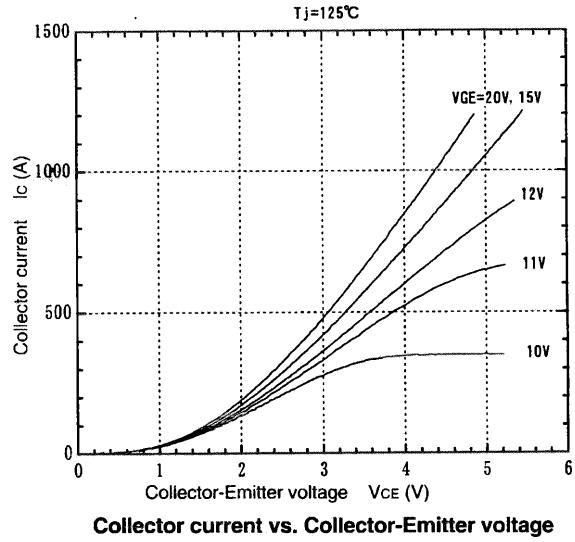
Items	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th(j-c)}$	IGBT	—	—	0.03	$^\circ\text{C}/\text{W}$
	$R_{th(j-c)}$	Diode	—	—	0.06	$^\circ\text{C}/\text{W}$
Contact Thermal resistance	$R_{th(c-f)}^*$	the base to cooling fin	—	0.0063	—	$^\circ\text{C}/\text{W}$

*4 : This is the value which is defined mounting on the additional cooling fin with thermal compound.

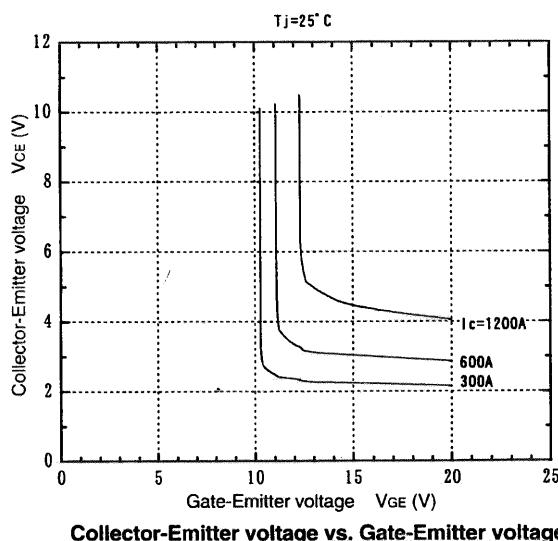
■ Characteristics (Representative)



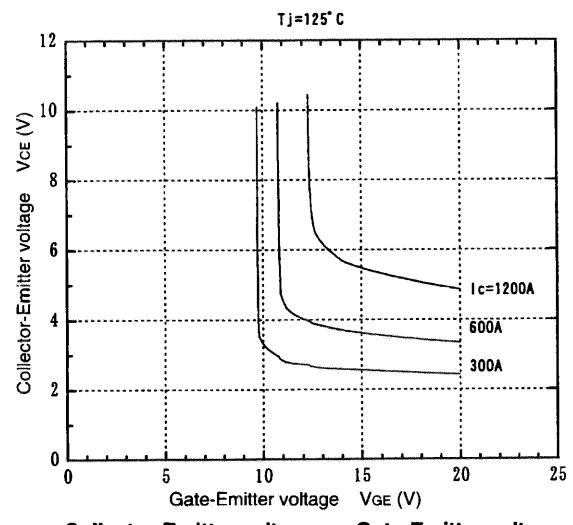
Collector current vs. Collector-Emitter voltage



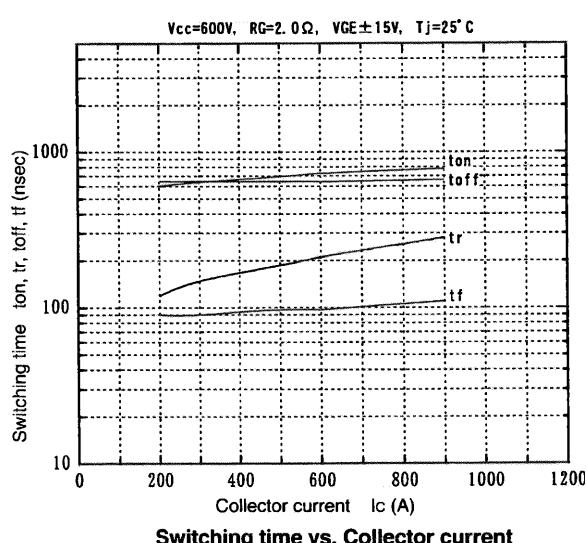
Collector current vs. Collector-Emitter voltage



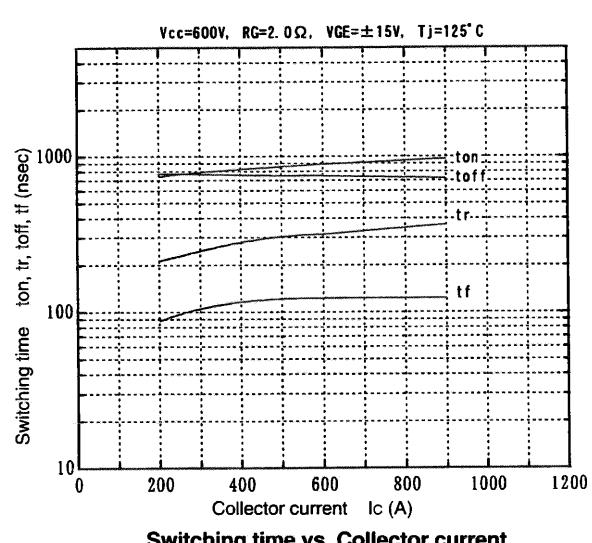
Collector-Emitter voltage vs. Gate-Emitter voltage



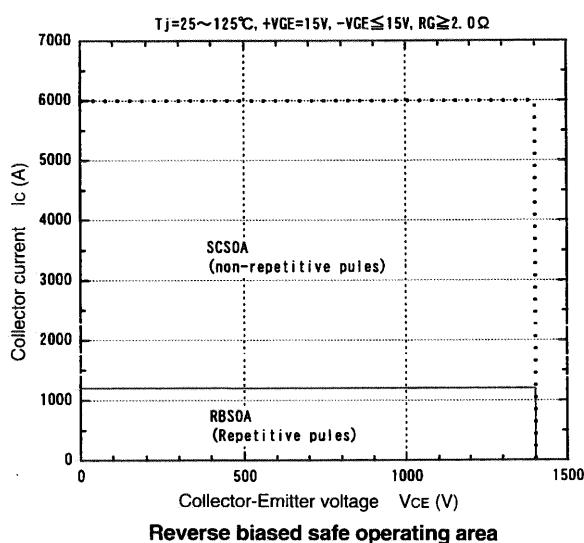
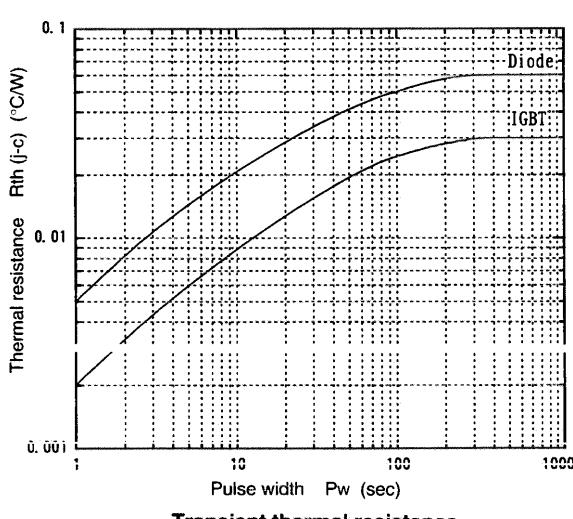
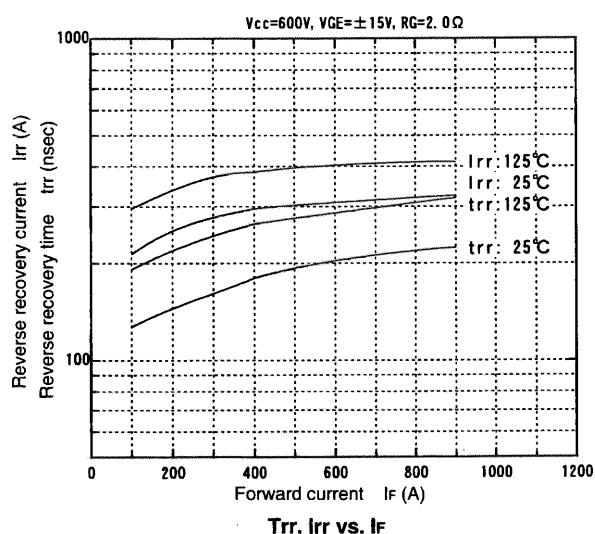
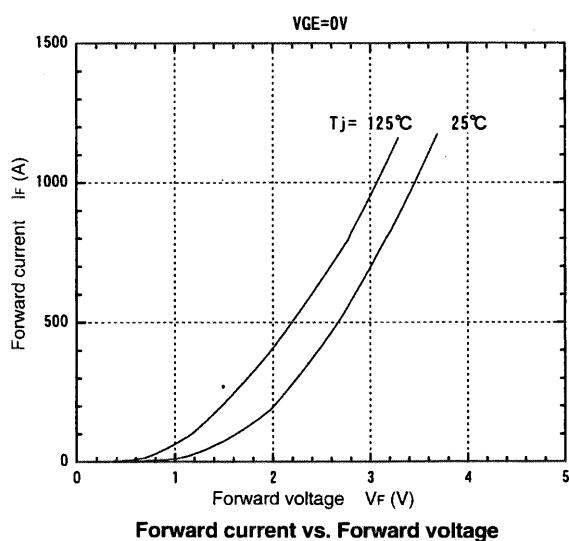
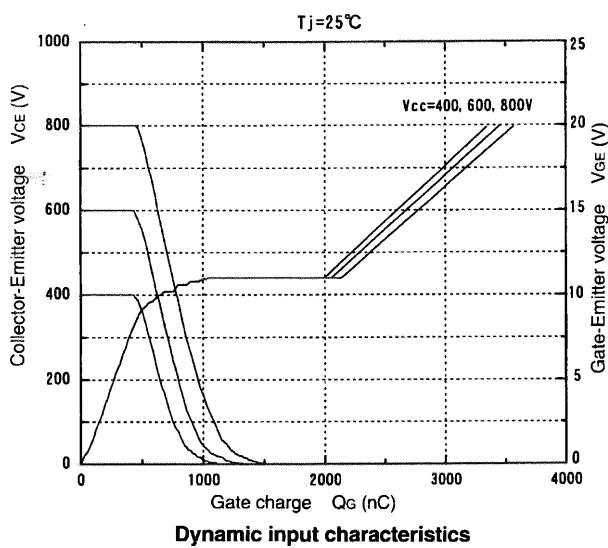
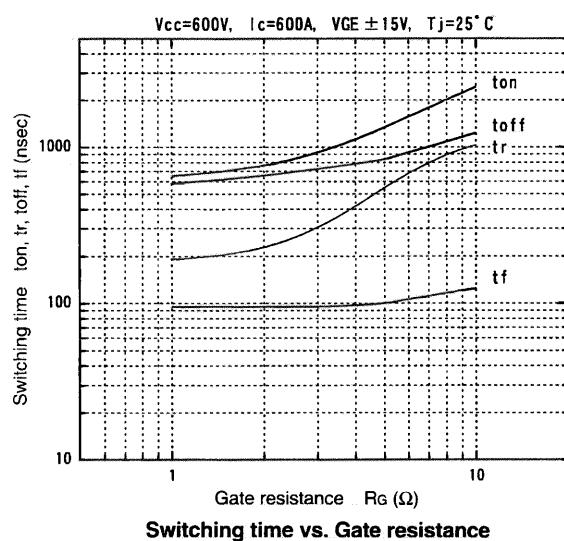
Collector-Emitter voltage vs. Gate-Emitter voltage

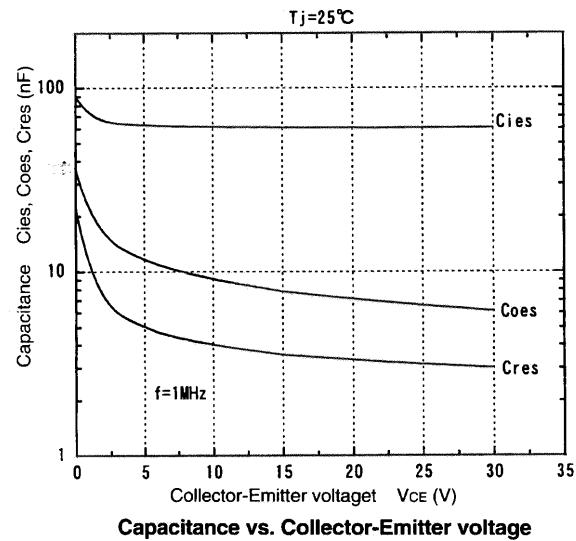
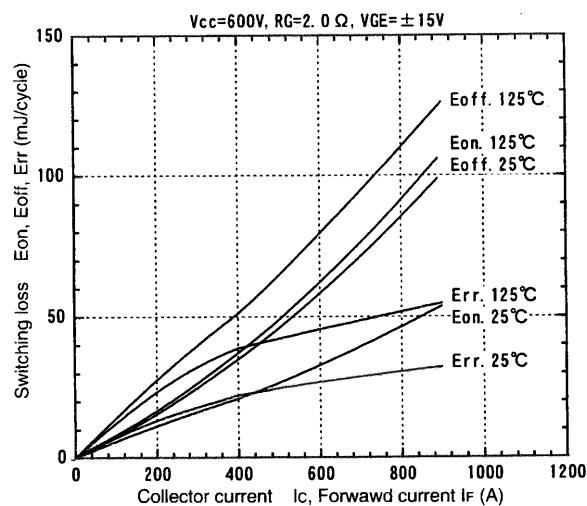


Switching time vs. Collector current



Switching time vs. Collector current





■ Outline Drawings, mm

M138

